

# Product/Process Change Notification

N° 2019-056-A

Dear customer,

please find attached our Infineon Technologies AG PCN:

**Change of wafer production and wafer test location from Infineon Technologies Austria AG, Villach, Austria and Infineon Technologies AG, Regensburg, Germany to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for BTS3160D**

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2021-09-06.
- Infineon aligns with the widely-recognized JEDEC STANDARD “JESD46”, which stipulates: “Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”  
Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance. We ask for your patience in the meantime. For further details, please visit our website:

<https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/>

Infineon Technologies AG

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Chairman of the Supervisory Board: Dr. Wolfgang Eder

Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Constanze Hufenbecher, Dr. Sven Schneider

Registered Office: Neubiberg

Commercial Register: München HRB 126492

# Product/Process Change Notification

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## Products affected

Please refer to attached affected product list 1\_cip19056\_A

## Detailed change information

### Subject:

Change of wafer production and wafer test location from Infineon Technologies Austria AG, Villach, Austria and Infineon Technologies AG, Regensburg, Germany to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for BTS3160D

### Reason/Motivation:

The wafer production and wafer test of the affected products will be transferred to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia according to the global Infineon production strategy.

### Description

	<u>Old</u>	<u>New</u>
<b>PROCESS - WAFER PRODUCTION:</b> <b>Move all or parts of production to a different wafer fab site</b>	<b>Wafer production base chip:</b> Infineon Technologies Austria AG, Villach, Austria  <b>Wafer production top chip:</b> Infineon Technologies AG, Regensburg, Germany	<b>Wafer production base and top chip:</b> Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia
<b>TEST FLOW:</b> <b>Move of all or part of electrical wafer test and/or final test to a different test site</b>	<b>Wafer test base and top chip:</b> Infineon Technologies Austria AG, Villach, Austria	<b>Wafer test base and top chip:</b> Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia

## Product identification

Wafer lot numbers from Villach start with VExxxxxx.  
 Wafer lot numbers from Regensburg start with RUxxxxxx.  
 Wafer lot numbers from Kulim start with 1Exxxxxx.  
 Traceability assured via date code.  
 No change in SP ordering number.

## Anticipated impact of change

Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in fit, form and function expected.

DeQuMa-ID(s): SEM-PW-13 / SEM-TF-01

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## Attachments

1\_cip19056\_A affected product list

## Time schedule

Final qualification report	available
First samples available	on request
Intended start of delivery [1]	2022-02-02
Last order date (LOD) [2]	2022-02-02
Last delivery date (LDD) [3]	2023-02-02

[1] Provided date or earlier after customer approval

[2] Last time buy volume to be placed latest until LOD

[3] Delivery of new product can be earlier (see Intended start of delivery) and depends on approval

If you have any questions, please do not hesitate to contact your local sales office.



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<b>Sales name</b>	<b>SP number</b>	<b>OPN</b>	<b>Package</b>
BTS3160D	SP000305175	BTS3160DAUMA1	PG-TO252-5-13